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PBSS5160U 60 V, 1 A PNP low V_{CEsat} (BISS) transistor Rev. 04 – 2 October 2008

Product data sheet

1. Product profile

1.1 General description

PNP low V_{CEsat} Breakthrough In Small Signal (BISS) transistor in a very small SOT323 (SC-70) Surface-Mounted Device (SMD) plastic package.

NPN complement: PBSS4160U.

1.2 Features

- Low collector-emitter saturation voltage V_{CEsat}
- High collector current capability I_C and I_{CM}
- High collector current gain (h_{FE}) at high I_C
- High efficiency due to less heat generation
- Smaller required Printed-Circuit Board (PCB) area than for conventional transistors

1.3 Applications

- High voltage DC-to-DC conversion
- High voltage MOSFET gate driving
- High voltage motor control
- High voltage power switches (e.g. motors, fans)
- Automotive applications

1.4 Quick reference data

Table 1.	Quick reference data					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V_{CEO}	collector-emitter voltage	open base	-	-	-60	V
I _C	collector current		<u>[1]</u> _	-	-1	А
I _{CM}	peak collector current	single pulse; $t_p \leq 1 \text{ ms}$	-	-	-2	A
R _{CEsat}	collector-emitter saturation resistance	$I_{C} = -1 \text{ A};$ $I_{B} = -100 \text{ mA}$	[2] _	255	340	mΩ

[1] Device mounted on a ceramic PCB, Al₂O₃, standard footprint.



60 V, 1 A PNP low V_{CEsat} (BISS) transistor

2. Pinning information

Table 2.	Pinning		
Pin	Description	Simplified outline	Graphic symbol
1	base		
2	emitter		3
3	collector	1 2	
			sym013

3. Ordering information

Table 3. Ord	ering infor	mation	
Type number Package			
	Name	Description	Version
PBSS5160U	SC-70	plastic surface-mounted package; 3 leads	SOT323

4. Marking

Table 4. Marking codes	
Type number	Marking code ^[1]
PBSS5160U	53*
[1] * = -: made in Hong Kong	

* = p: made in Hong Kong

- * = t: made in Malaysia
- * = W: made in China

5. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

			,		
Symbol	Parameter	Conditions	Min	Max	Unit
V _{CBO}	collector-base voltage	open emitter	-	-80	V
V _{CEO}	collector-emitter voltage	open base	-	-60	V
V _{EBO}	emitter-base voltage	open collector	-	-5	V
I _C	collector current		<u>[1]</u> _	-0.7	А
			[2] _	-0.86	А
			[3] _	-1	А
I _{CM}	peak collector current	single pulse; $t_p \le 1 \text{ ms}$	-	-2	A
I _B	base current		-	-300	mA
I _{BM}	peak base current	single pulse; t _p ≤ 1 ms	-	-1	А

60 V, 1 A PNP low V_{CEsat} (BISS) transistor

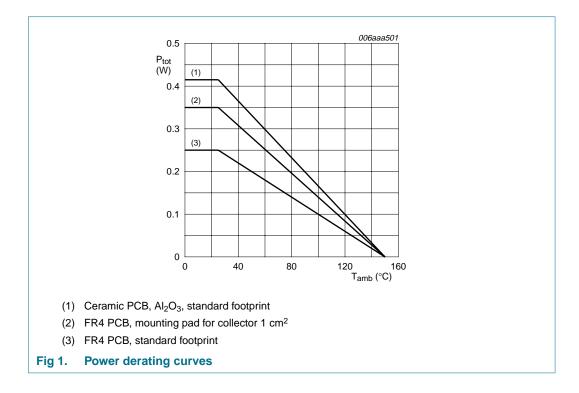
In accordance with the Absolute Maximum Rating System (IEC 60134).

	,				
Symbol	Parameter	Conditions	Min	Max	Unit
P _{tot}	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$	<u>[1]</u> _	250	mW
			[2] _	350	mW
			<u>[3]</u>	415	mW
Tj	junction temperature		-	150	°C
T _{amb}	ambient temperature		-65	+150	°C
T _{stg}	storage temperature		-65	+150	°C

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 1 cm².

[3] Device mounted on a ceramic PCB, AI_2O_3 , standard footprint.



60 V, 1 A PNP low V_{CEsat} (BISS) transistor

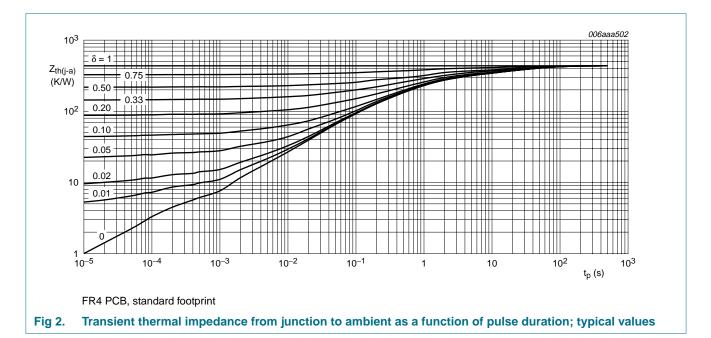
6. Thermal characteristics

Table 6.	Thermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-a)}	thermal resistance from	in free air	<u>[1]</u> _	-	500	K/W
junc	junction to ambient		[2] _	-	357	K/W
			[3] _	-	301	K/W
R _{th(j-sp)}	thermal resistance from junction to solder point		-	-	150	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 1 cm².

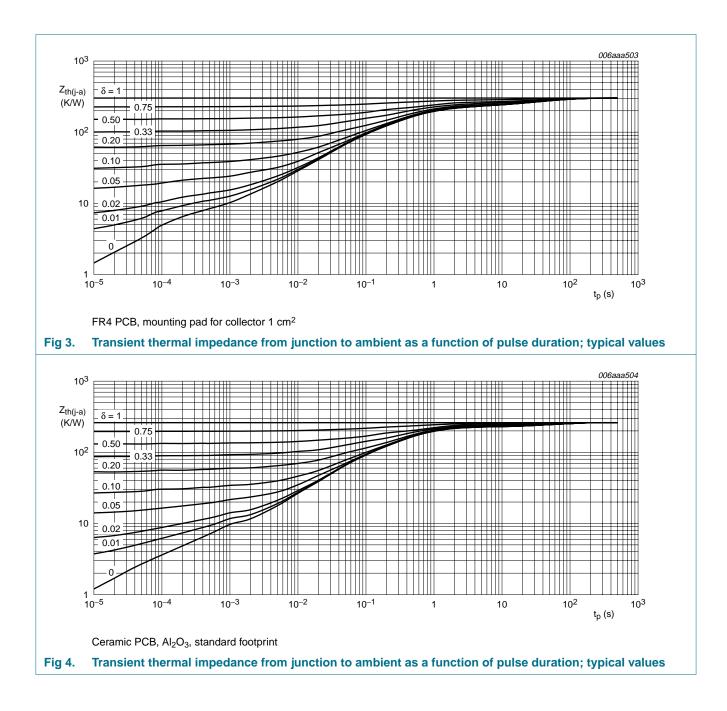
[3] Device mounted on a ceramic PCB, Al₂O₃, standard footprint.



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PBSS5160U

60 V, 1 A PNP low V_{CEsat} (BISS) transistor

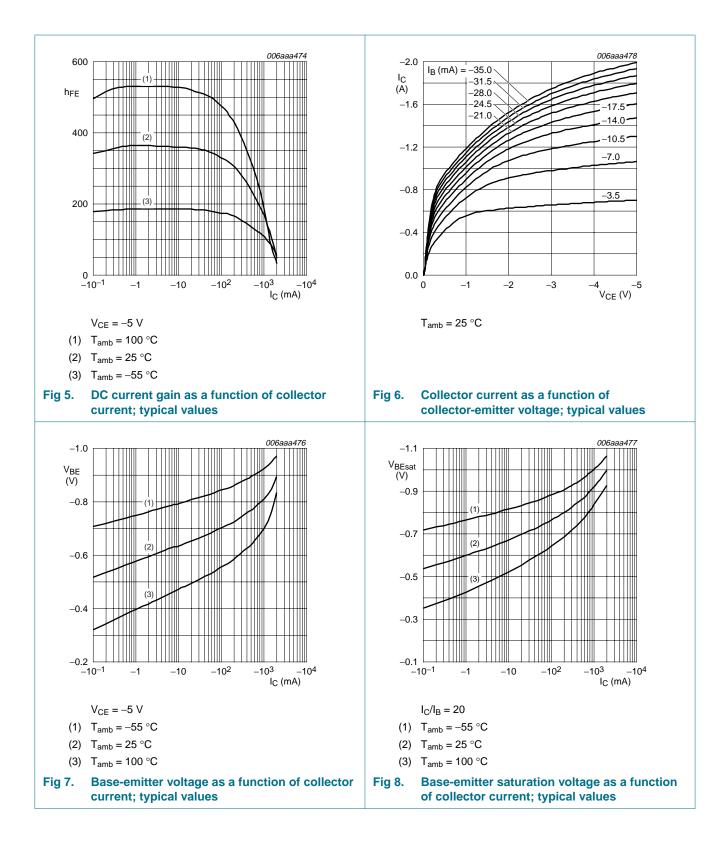


60 V, 1 A PNP low V_{CEsat} (BISS) transistor

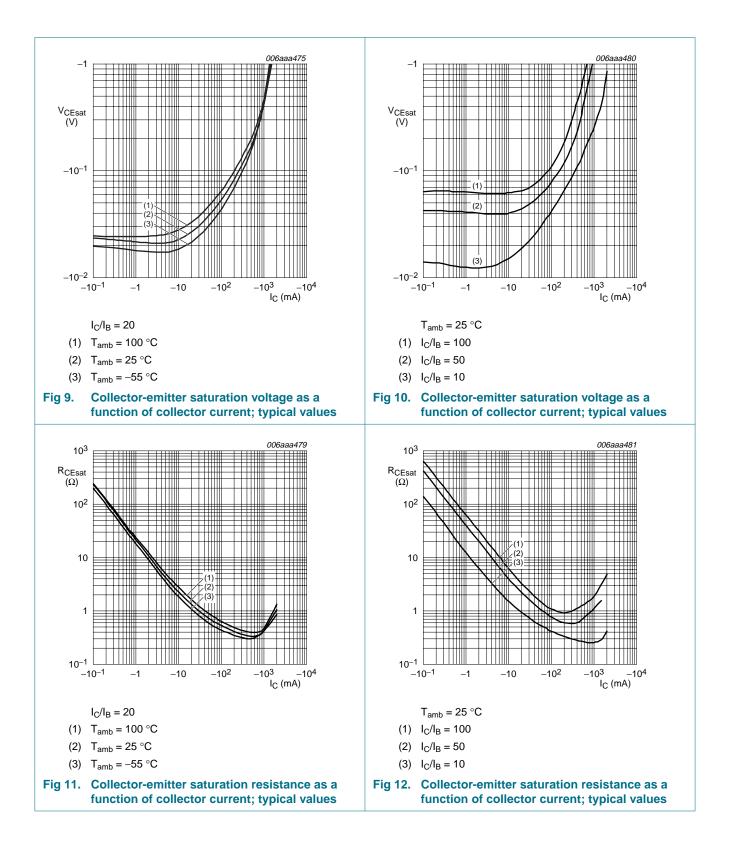
7. Characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I _{CBO}	collector-base cut-off	$V_{CB} = -60 \text{ V}; I_E = 0 \text{ A}$		-	-	-100	nA
	current	$\label{eq:VCB} \begin{split} V_{CB} &= -60 \text{ V}; \text{ I}_E = 0 \text{ A}; \\ T_j &= 150 \ ^\circ\text{C} \end{split}$		-	-	-50	μΑ
I _{CES}	collector-emitter cut-off current	$V_{CE} = -60 \text{ V}; V_{BE} = 0 \text{ V}$		-	-	-100	nA
I _{EBO}	emitter-base cut-off current	$V_{EB} = -5 \text{ V}; I_C = 0 \text{ A}$		-	-	-100	nA
h _{FE}	DC current gain	$V_{CE} = -5 \text{ V}; \text{ I}_{C} = -1 \text{ mA}$		200	350	-	
		$V_{CE} = -5 \text{ V}; I_{C} = -500 \text{ mA}$	<u>[1]</u>	150	250	-	
		$V_{CE} = -5 \text{ V}; \text{ I}_{C} = -1 \text{ A}$	<u>[1]</u>	100	160	-	
V _{CEsat}	collector-emitter	$I_{C} = -100 \text{ mA}; I_{B} = -1 \text{ mA}$		-	-110	-175	mV
saturation voltage	$I_{C} = -500 \text{ mA}; I_{B} = -50 \text{ mA}$		-	-135	-180	mV	
	$I_{C} = -1 \text{ A}; I_{B} = -100 \text{ mA}$	<u>[1]</u>	-	-255	-340	mV	
V _{BEsat}	base-emitter saturation voltage	$I_{C} = -1$ A; $I_{B} = -50$ mA		-	-0.95	-1.1	V
R _{CEsat}	collector-emitter saturation resistance	$I_{\rm C} = -1$ A; $I_{\rm B} = -100$ mA	<u>[1]</u>	-	255	340	mΩ
V _{BEon}	base-emitter turn-on voltage	$I_{C} = -1$ A; $V_{CE} = -5$ V		-	-0.82	-0.9	V
t _d	delay time	$I_{C} = -0.5 \text{ A}; I_{Bon} = -25 \text{ mA};$		-	11	-	ns
t _r	rise time	I _{Boff} = 25 mA		-	30	-	ns
t _{on}	turn-on time			-	41	-	ns
t _s	storage time			-	205	-	ns
t _f	fall time			-	55	-	ns
t _{off}	turn-off time			-	260	-	ns
f _T	transition frequency	$V_{CE} = -10$ V; $I_{C} = -50$ mA; f = 100 MHz		150	185	-	MHz
C _c	collector capacitance	$V_{CB} = -10 \text{ V}; \text{ I}_{E} = \text{i}_{e} = 0 \text{ A};$ f = 1 MHz		-	9	15	pF

60 V, 1 A PNP low V_{CEsat} (BISS) transistor

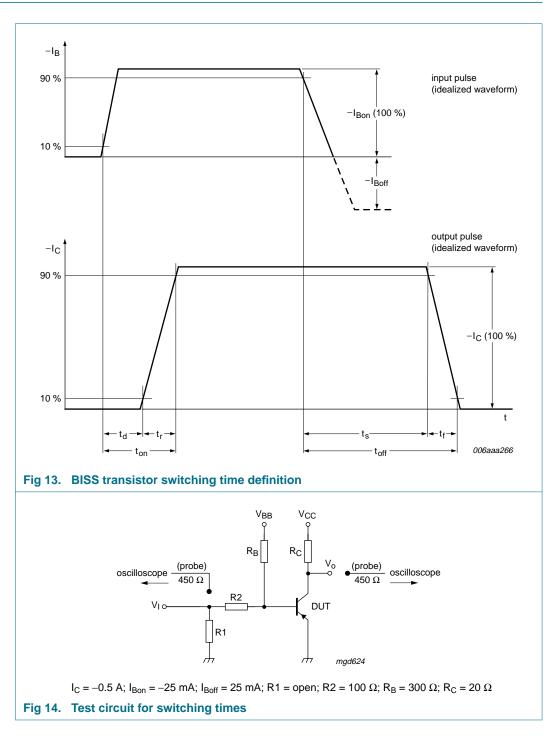


60 V, 1 A PNP low V_{CEsat} (BISS) transistor



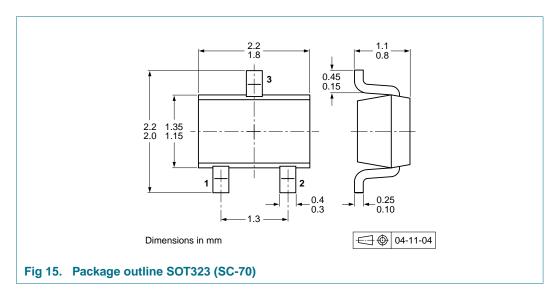
60 V, 1 A PNP low V_{CEsat} (BISS) transistor

8. Test information



60 V, 1 A PNP low V_{CEsat} (BISS) transistor

9. Package outline



10. Packing information

Table 8.Packing methods

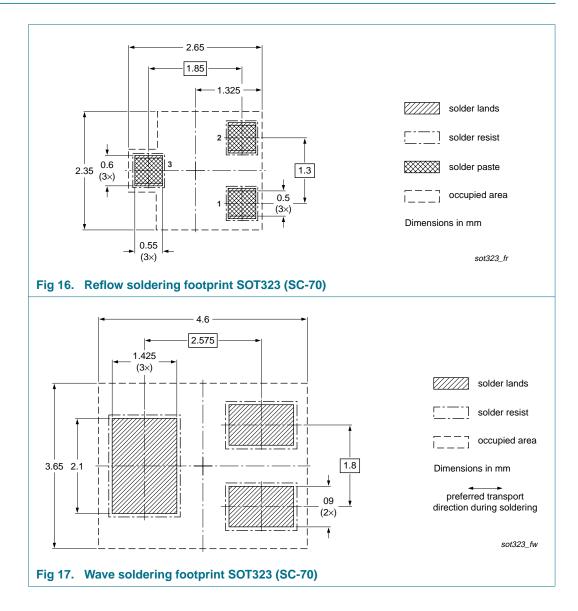
The indicated -xxx are the last three digits of the 12NC ordering code.[1]

Type number	Package	Description	Packing	quantity
			3000	10000
PBSS5160U	SOT323	4 mm pitch, 8 mm tape and reel	-115	-135

[1] For further information and the availability of packing methods, see <u>Section 14</u>.

60 V, 1 A PNP low V_{CEsat} (BISS) transistor

11. Soldering



60 V, 1 A PNP low V_{CEsat} (BISS) transistor

12. Revision history

Table 9. Revision h	nistory			
Document ID	Release date	Data sheet status	Change notice	Supersedes
PBSS5160U_4	20081002	Product data sheet	-	PBSS5160U_3
Modifications:		of this data sheet has been of NXP Semiconductors.	redesigned to comply w	with the new identity
	 Legal texts 	have been adapted to the n	iew company name whe	ere appropriate.
	 Figure 9: ar 	nended		
	Section 13	"Legal information": updated	d	
PBSS5160U_3	20050811	Product data sheet	-	PBSS5160U_2
PBSS5160U_2	20040809	Objective data sheet	-	PBSS5160U_1
PBSS5160U_1	20040503	Objective data sheet	-	-

60 V, 1 A PNP low V_{CEsat} (BISS) transistor

13. Legal information

13.1 Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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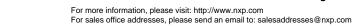
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